

3HE15378AB-OPC

Alcatel-Lucent Nokia® 3HE15378AB Compatible TAA 25GBase-BX SFP28 Transceiver (SMF, 1330nmTx/1270nmRx, 10km, LC, DOM, -40 to 85C)

Features

- SFF-8402 and SFF-8472 Compliance
- Simplex LC Connector
- Single-mode Fiber
- Industrial Temperature -40 to 85 Celsius
- Hot Pluggable
- Metal with Lower EMI
- Excellent ESD Protection
- RoHS Compliant and Lead Free



Applications:

- 25GBase Ethernet
- Access and Enterprise

Product Description

This Alcatel-Lucent Nokia® 3HE15378AB compatible SFP28 transceiver provides 25GBase-BX throughput up to 10km over single-mode fiber (SMF) using a wavelength of 1330nmTx/1270nmRx via an LC connector. This bidirectional unit must be used with another transceiver or network appliance of complementing wavelengths. It is capable of withstanding rugged environments and can operate at temperatures between -40 and 85C. Our transceiver is built to meet or exceed OEM specifications and is guaranteed to be 100% compatible with Alcatel-Lucent Nokia®. It has been programmed, uniquely serialized, and tested for data-traffic and application to ensure that it will initialize and perform identically. All of our transceivers comply with Multi-Source Agreement (MSA) standards to provide seamless network integration. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Maximum Supply Voltage	Vcc	0		3.6	V	+3.3V
Storage Temperature	TS	-40		85	°C	
Operating Case Temperature	Tc	-40	25	85	°C	
Optical Receiver Input	Pmax			+5.5	dBm	Average

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Power Supply Voltage	Vcc	3.135	3.30	3.465	V	
Power Supply Noise	Vrip			2 3	% %	DC – 1MHz 1 – 10MHz
Power Consumption	Pw			1.2	W	

High Speed Electrical Characteristics

Parameter	Test Point	Min.	Typ.	Max.	Unit	Notes/ Conditions
High Speed Electrical Input Characteristics						
Overload differential voltage (peak-to-peak)	TP1a	900			mV	Calibrated at TP1a Note 3: Section 13.3.12
Differential termination mismatch	TP1			10	%	At 1 MHz Note 3: Section 13.3.6
Differential return loss (SDD11)	TP1			Note 1	dB	
Common mode to differential conversion and differential to common mode conversion (SDC11, SCD11)	TP1			Note 2	dB	
High Speed Electrical Output Characteristics						
Differential voltage, pk-pk	TP4			900	mV	
Common mode noise, RMS	TP4			17.5	mV	Note 6: Section 13.3.5
Differential termination mismatch	TP4			10	%	At 1 MHz
Differential return loss (SDD22)	TP4			Note 4	dB	
Common mode to differential conversion and differential to common mode conversion (SDC22, SCD22)	TP4			Note 5		
Transition Time, 20 to 80%	TP4	9.5			ps	Note 6: Section 13.3.10
Vertical Eye Closure (VEC)				5.5	dB	Note 6: Section 13.3.11
Eye width at 10-15 probability (EW15)	TP4	0.57			UI	Note 6: Section 13.3.11
Eye height at 10-15 probability (EH15)	TP4	228			mV	Note 6: Section 13.3.11

Notes:

1. SDD11, SDD22 < -11dB for $0.05 < f < f_b/7$ ($f_b=28\text{GHz}$)
SDD11, SDD22 < $-6.0+9.2*\log_{10}(2f/f_b)$ dB for $f_b/7 < f < f_b$ ($f_b=28\text{ GHz}$)
2. SDC11, SCD11 < $-22+14*(f/f_b)$ dB for $0.05 < f < f_b/2$ ($f_b=28\text{ GHz}$)
SDC11, SCD11 < $-18+6*f/f_b$ dB for $f_b/2 < f < f_b$ ($f_b=28\text{ GHz}$)
3. Ref OIF-CEI-28G-VSR as described in Implementation Agreement OIF-CEI-03.1
4. SDD11, SDD22 < -11dB for $0.05 < f < f_b/7$ ($f_b=28\text{GHz}$)
SDD11, SDD22 < $-6.0+9.2*\log_{10}(2f/f_b)$ dB for $f_b/7 < f < f_b$ ($f_b=28\text{ GHz}$)
5. SDC22, SCD22 < $-25+20*(f/f_b)$ dB for $0.05 < f < f_b/2$ ($f_b=28\text{ GHz}$)
SDC22, SCD22 < $-18+6*f/f_b$ dB for $f_b/2 < f < f_b$ ($f_b=28\text{ GHz}$)
6. Ref OIF-CEI-28G-VSR as described in Implementation Agreement OIF-CEI-03.1

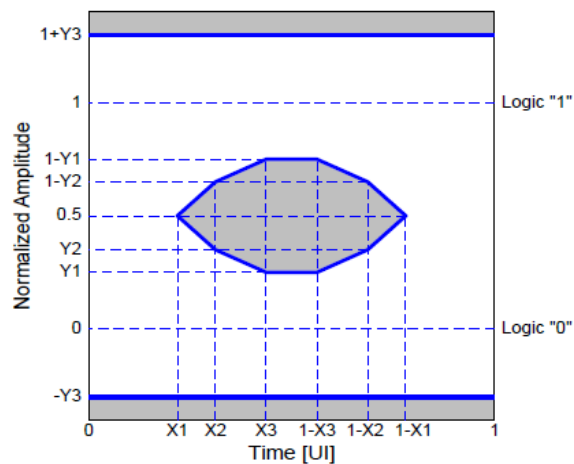
Optical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter						
Data Rate	fDC	25.78125			Gbps	1
Signal speed variation from nominal	ΔfD	-100		+100	ppm	
Transmitter center wavelength	λC	1320	1330	1340	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average launch power	PTavg	-5		+3	dBm	
Optical output power in OMA	OMA	-4		+2.2	dBm	
Launch power in OMA minus TDP		-5			dBm	
Transmitter and dispersion penalty (TDP)	TDP			2.7	dB	
Average launch power of OFF transmitter	Poff			-30	dBm	
Extinction ratio	ER	3			dB	
Transmitter eye mask definition		Figure Below				
Receiver						
Receiver center wavelength	λC	1260	1270	1280	nm	
Receiver sensitivity in OMA	PminOMA			-12	dBm	2, 3
Stressed receiver sensitivity in OMA	PminSOMA			-9.5	dBm	2
Average received power	PRavg			+2.2	dBm	

Notes:

1. Testing by Data Rate; NRZ at 25.78125 Gbps, Mark Ratio 50%, PRBS=2³¹-1
2. For BER 5x10⁻⁵
3. Receiver Sensitivity in OMA is a normative specification.

Mask of Optical Output Eye Diagram



X1	X2	X3	Y1	Y2	Y3	Max Hit Ratio (Note)
0.31	0.4	0.45	0.34	0.38	0.4	5×10^{-5}

Note: The acceptable ratio of samples inside to outside the hatched area (the “hit ratio”) must be met.

Low Speed Control Pin Logic Levels

Parameter	Symbol	Min.	Max.	Unit	Conditions/Notes
Host VCC Range	Host_VCC	3.14	3.47	V	with $\pm 5\%$ variation
TX_Fault, RX_LOS	VOL	0.0	0.40	V	Note 1
	VIL	Host_VCC – 0.5	Host_VCC + 0.3	V	Note 1
TX_Disable	VIL	-0.3	0.8	V	Pulled up with 10k ohms to VccT in the module.
	VIH	2.0	VCC _T + 0.3	V	

Notes:

1. Rpullup (Rp) is the pull up resistor. Active bus termination may be used by the host in place of a pullup resistor. Pull ups can be connected to multiple power supplies, however the host board design shall ensure that no module pin has voltage exceeding module. Measured at the Host side of the connector.

TX_Fault is a module output pin that when High, indicates that the module transmitter has detected a fault condition related to laser operation or safety. The TX_Fault output pin is an open drain/collector and must be pulled up to the Host_Vcc with 4.7k-10kΩ on the host board

TX_Disable is a module input pin. When TX_Disable is asserted High or left open, the SFP+ module transmitter output must be turned off. The TX_Disable pin is pulled up to VccT with 10kΩ in the SFP+ module. The TX_Disable pin works for TX_fault_Reset as well.

Mod_ABS is pulled up to Host_Vcc with 4.7k-10kΩ on the host board and connected to VeeT or VeeR in the SFP+ module. Mod_ABS is then asserted “High” when the SFP+ module is physically absent from a host slot. In the SFP MSA (INF8074i) this pin had the same function but is called MOD_DEF0.

RX_LOS when high indicates an optical signal level below that specified in the relevant standard. The RX_LOS pin is an open drain/collector output and must be pulled up to host Vcc with a 4.7k-10kΩ on the host board. RX_LOS assert min and de-assert max are defined in the relevant standard.

CDR Control for Bypass Mode

- Default value for “Soft RS0” and “Soft RS1” is ‘0’
- Hard pin#7 for RS0 and hard pin#9 for RS1 are terminated to Ground through 30kohm.

	Hard: Pin #7	Soft: A2h, Byte 110 bit 3	Mode of Operation
RSO	0	0	CDRR bypass mode
	0	1	CDRR engaged mode
	1	0	CDRR engaged mode
	1	1	CDRR engaged mode

	Hard: Pin #9	Soft: A2h, Byte 118 bit 3	Mode of Operation
RS1	0	0	CDRT bypass mode
	0	1	CDRT engaged mode
	1	0	CDRT engaged mode
	1	1	CDRT engaged mode

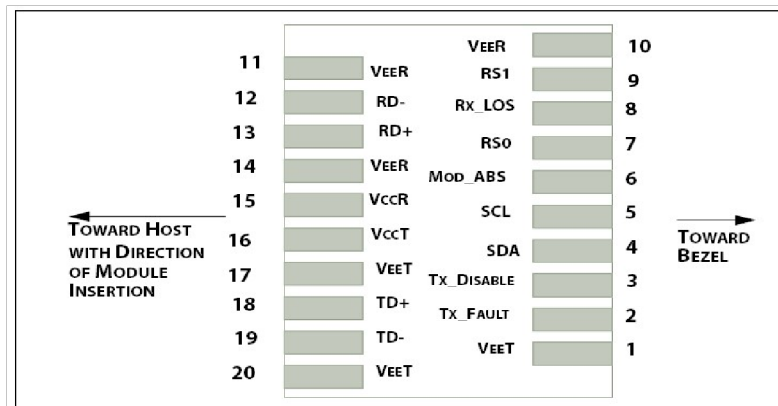
Pin Description

PIN	Symbol	Name / Description	Notes
1	VeeT	Transmitter Ground	1
2	TX_Fault	Transmitter Fault (LVTTTL-O) - High indicates a fault condition	2
3	TX_Disable	Transmitter Disable (LVTTTL-I) – High or open disables the transmitter	3
4	SDA	Two wire serial interface Data Line (LVCMOS-I/O) (MOD-DEF2)	4
5	SCL	Two wire serial interface Clock Line (LVCMOS-I/O) (MOD-DEF1)	4
6	MOD_ABS	Module Absent (Output), connected to VeeT or VeeR in the module	5
7	RS0	NA	6
8	RX_LOS	Receiver Loss of Signal (LVTTTL-O)	2
9	RS1	NA	6
10	VeeR	Receiver Ground	1
11	VeeR	Receiver Ground	1
12	RD-	Inverse Received Data out (CML-O)	
13	RD+	Received Data out (CML-O)	
14	VeeR	Receiver Ground	1
15	VccR	Receiver Power - +3.3V	
16	VccT	Transmitter Power - +3.3 V	
17	VeeT	Transmitter Ground	1
18	TD+	Transmitter Data In (CML-I)	
19	TD-	Inverse Transmitter Data In (CML-I)	
20	VeeT	Transmitter Ground	1

Notes:

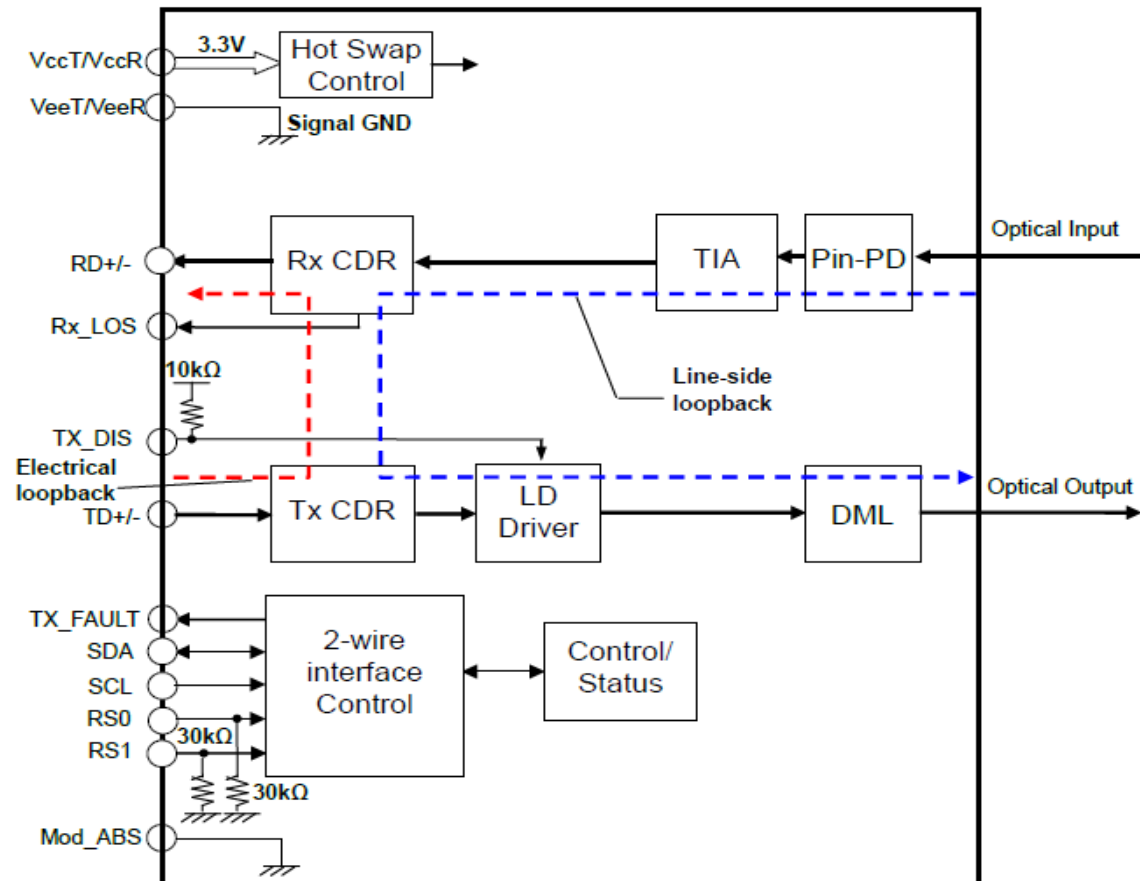
1. The module signal grounds are isolated from the module case.
2. This is an open collector/drain output that on the host board requires a 4.7K Ω to 10K Ω pull-up resistor to VccHost.
3. This input is internally biased high with a 4.7K Ω to 10K Ω pull-up resistor to VccT.
4. Two-Wire Serial interface clock and data lines require an external pull-up resistor dependent on the capacitance load.
5. This is a ground return that on the host board requires a 4.7K Ω to 10K Ω pull-up resistor to VccHost.
6. Rate select can also be set through the 2-wire bus in accordance with SFF-8472 v. 12.1, Rx Rate Select is set at Bit 3, Byte 110, Address A2h. Tx Rate Select is set at Bit 3, Byte 118, Address A2h.

Note: writing a "1" selects maximum bandwidth operation. Rate select is the logic OR of the input state of Rate Select Pin and 2-wire bus.



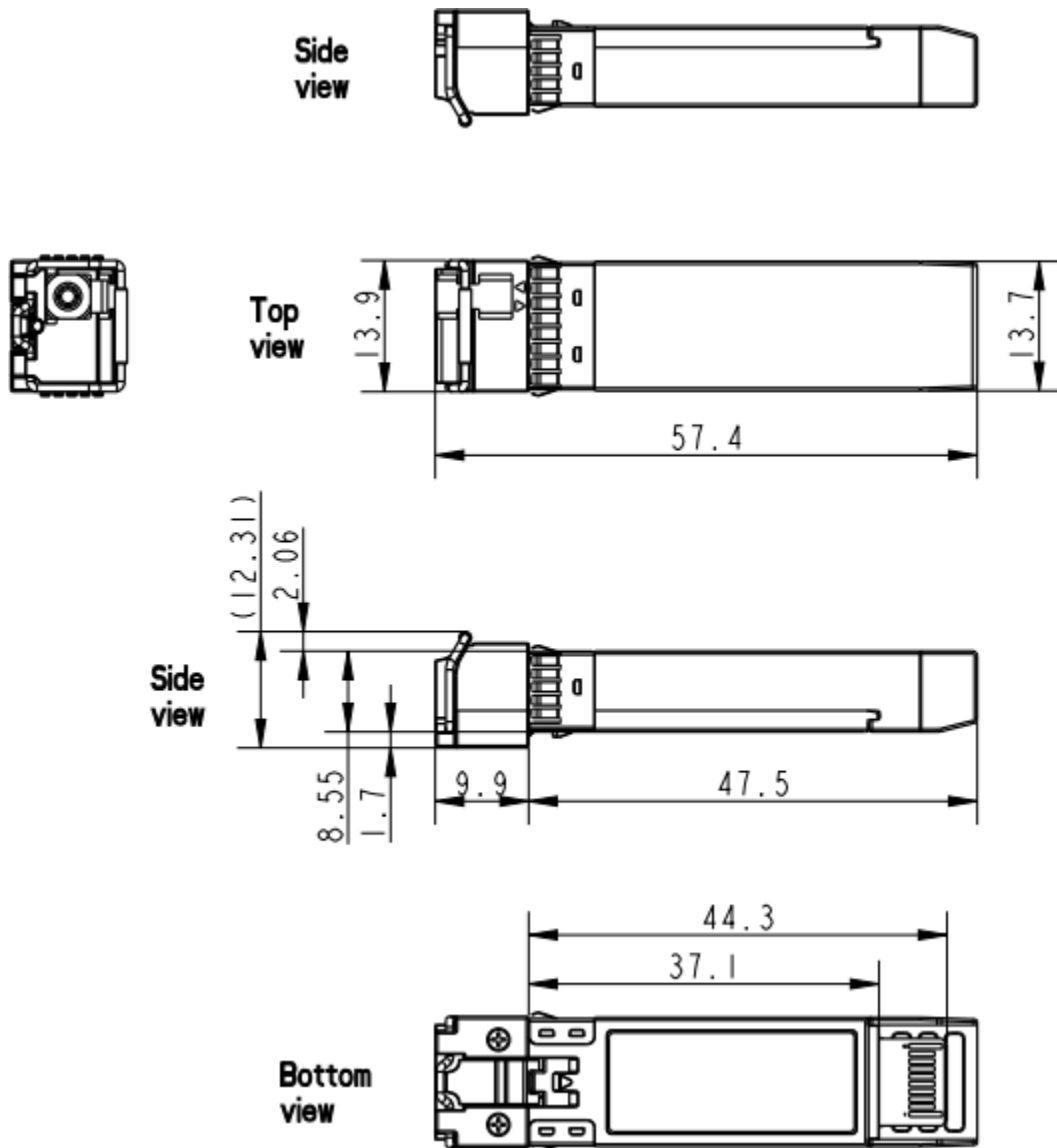
Pin-out of connector Block on Host board

Functional Block Diagram



Mechanical Specifications

Small Form Factor Pluggable (SFP) transceivers are compatible with the dimensions defined by the SFP Multi-Sourcing Agreement (MSA).



EEPROM Information

EEPROM memory map specific data field description is as below:

